

DCS04S0A0S06NFA















The Delphi Series DCS, 2.4-5.5V input, single output, non-isolated Point of Load DC/DC converters are the latest offering from a world leader in power systems technology and manufacturing -- Delta Electronics, Inc. The DCS series provides a programmable output voltage from 0.6V to 3.3V using an external resistor and has flexible and programmable tracking features to enable a variety of startup voltages as well as tracking between power modules. This product family is available in surface mount and provides up to 6A of output current in an industry standard footprint. With creative design technology and optimization of component placement, these converters possess outstanding electrical and thermal performance, as well as extremely high reliability under highly stressful operating conditions.

FEATURES

- High efficiency: 94% @ 5.0Vin, 3.3V/6A out
- Small size and low profile:
 12.2x 12.2x 7.25mm (0.48"x 0.48"x 0.29")
- Surface mount packaging
- Standard footprint
- Voltage and resistor-based trim
- Pre-bias startup
- Output voltage tracking
- · No minimum load required
- Output voltage programmable from 0.6Vdc to 3.3Vdc via external resistor
- Fixed frequency operation
- Input UVLO, output OCP
- Remote on/off
- ISO 9001, TL 9000, ISO 14001, QS9000, OHSAS18001 certified manufacturing facility
- UL/cUL 60950-1 (US & Canada)

OPTIONS

- Negative on/off logic
- Tracking feature

APPLICATIONS

- Telecom / DataCom
- Distributed power architectures
- Servers and workstations
- LAN / WAN applications
- Data processing applications



Input Ripple Rejection (120Hz)	PARAMETER	NOTES and CONDITIONS	DCS04S0A0S06NFA			
1.0.3 6 1.0.5 1.0.5 6 1.0.5	<u> </u>			·		Units
Tracking Voltage						
Department Dep						Vdc Vdc
Storage Femperature 55						°C
Department injust Voltage Vo S Vin -0.6						°C
Part Uniter Votage Threshold						
		Vo ≦ Vin –0.6	2.4		5.5	V
Unit-Off Voltage Threshold				0.0		
						V
Non-Section		Vin=2 4V to 5 5V lo=lo max		2.0	6.5	A
nush Transient pout Reflected Ripple Current, peak to peak pout Reflected Ripple Current, peak to peak pout Reflected Ripple Current, peak to peak pout Ripple Registion (120Hz) Disput Violage Registion (120Hz) Disput Violage Registion (120Hz) Disput Violage Registion Disput Violage Registion Disput Violage Registion Por Violage Registion Possitive Reg				15		mA
1998 1999		Vin=5V		5	1	mA A2S
DUIDUT Violage Set Point with 0.5% tolerance for external resistor used to set output voltage) -1.5 Vo.set +1.5 9. Dutput Voltage Regulation Over Line For Vor-2.5V 0.6 3.33 Over Load For Vor-2.5V 0.4 % Over Load For Vor-2.5V 10 For Vor-2.5V 10 Over Temperature Tar-40°C to 85°C 5 5 5 Over Temperature Tar-40°C to 85°C 0.4 % 0.4 % Over Temperature Tar-40°C to 85°C 0.4 % 0.4 % 0.4 % Over Sende Load, Inc Coramic, 10pE frantalum 3.0 3.0 4.0 % 3.0 5.5<	nput Reflected Ripple Current, peak-to-peak	(5Hz to 20MHz, 1µH source impedance; VIN =0 to 5.5V, lo= lomax;				mAp-
Dutyput Voltage Ref Point	nput Ripple Rejection (120Hz)			40		dB
Disput Voltage Set Point external resistor used to set output voltage) 4.5 Vo.set +1.5 % Oset 1.0 **	DUTPUT CHARACTERISTICS					
Doubut Voltage Regulation	Output Voltage Set Point	man did /d toloraned loi	-1.5	Vo,set	+1.5	% Vo,s
For Yo>=2 5V 0.4 %			0.6		3.63	V
For Vox=2.5V	Output Voltage Regulation	F. W. 05/			0 :	0/ 1/
For Voy2-2-SV	Over Line					% Vo,s mV
Per Voc2 50 Fer Voc2 50 Fer Voc2 50 Sir C O.4 %						mV
Divide Tail Divide	Over Load					mV
Dutput Voltage Ripple and Noise					0.4	% Vo,s
Peak-to-Peak Full Load, 1µF ceramic, 10µF Instalum 25 35 35 35 35 35 35 35			-3.0		+3.0	% Vo,s
Full Load, 1μF ceramic, 10μF tantalum 10 15 15 15 15 15 15 15				05	0.5	- 1
Dutput Voltage Step Change in Output Current Negative Step Change in Output Current Settling Time to 10% of Peak Deviation Voltage Rise Time for Vo to rise from 10% to 90% of Vo.set 2						mV mV
Dutput Voltage Over-shoot at Start-up Vouri-3.3V Juput Courrent (Hiccup Mode) Ilicoup mode Juput Short-Circuit Current (Hiccup Mode) Ilicoup mode Juput Short-Circuit Current (Hiccup Mode) Ilicoup mode Juput Short-Circuit Current (Hiccup Mode) Ilioup mode Juput Short-Circuit Current Short-Circuit Step Change in Output Current Short-Circuit Short-Circu	-	Tuli Load, Thi Ceramic, Tohi tamaidin	0	10		A
Duty t Short-Circuit Current (Hiccup Mode) Do. S/C		Vout=3.3V				% Vo,s
Dynamic Load Response 2.5A/µs, Co=47u, Vin=5V, Vo=1.8V 2.5A/µs, Co=47u, Vin=5V, Vo=1.8V 180	Output DC Current-Limit Inception	Hiccup mode			200	% lo
Dynamic Load Response		lo,s/c		1		Adc
Positive Step Change in Output Current D-50% follows 180 180 180	DYNAMIC CHARACTERISTICS	40 FT - 0.4 F O				
Positive Step Change in Output Current Negative Step Change in Output Current Setting Time to 10% of Peak Deviation Solid Institute Setting Time to 10% of Peak Deviation Solid Institute Setting Time to 10% of Peak Deviation Solid Institute Soli	Dynamic Load Response					
Negative Step Change in Output Current 50% Iomax-0 500 500 500	Positive Step Change in Output Current			180		mV
Isan-Up Time, From On/Off Control Von/off, Vo=10% of Vo,set 2 2 2 2 2 2 2 2 2	Negative Step Change in Output Current					mV
Start-Up Time, From On/Off Control Von/off, Vo=10% of Vo,set 2 2				500		μs
Start-Up Time, From Input Vin=Vin,min, Vo=10% of Vo,set 2 5						
Output Voltage Rise Time Time for Vo to rise from 10% to 90% of Vo.set 2 5 Output Capacitive Load Full load; ESR ≥ 0.15mΩ 47 1000 Full load; ESR ≥ 10mΩ 47 3000 EFFICIENCY Vin=5V, 100% Load 94.0 70.0 Vo=2.5V Vin=5V, 100% Load 91.5 91.5 Vo=1.8V Vin=5V, 100% Load 88.0 90.5 Vo=1.5V Vin=5V, 100% Load 85.0 76.0 Vo=1.5V Vin=5V, 100% Load 85.0 76.0 Vo=0.6V Vin=5V, 100% Load 85.0 76.0 FATURE CHARACTERISTICS Switching Frequency 600 85.0 SWICHING Frequency 600 85.0 76.0 DNOFF Control, (Negative logic) 90.0 90.0 90.0 90.0 Logic High Voltage Module On, Ion/off Vin-0.8 Vin,max Vin,max Logic High Voltage Module Off, Ion/off 0.2 1 Logic Low Voltage Module Off, Von/off -0.3 0.3 Logic Low Current		·				ms ms
Dutput Capacitive Load					5	ms
Full load; ESR ≥ 10mΩ		Full load; ESR ≥ 0.15 m Ω	47	_		μF
Vin=5V, 100% Load			47		3000	μF
Vin=5V, 100% Load 91.5 9						
Vin=5V, 100% Load 89.5 88.0 Vin=5V, 100% Load 88.0 88.0 Vin=5V, 100% Load 85.0 85.0 Vin=5V, 100% Load 76.0 85.0 Vin=5V, 100% Load 76.0 85.0 Vin=5V, 100% Load 76.0						%
Vin=1.5V Vin=5V, 100% Load 88.0 85.0 Vin=5V, 100% Load 85.0 Vin=5V, 100% Load 76.0 Vin=5V, 100% Load V						% %
Vin=5V, 100% Load 85.0 76.0 7						%
Switching Frequency DN/OFF Control, (Negative logic) Logic Low Voltage Module On, Von/off Logic Light Voltage Module Off, Von/off Logic High Current Nodule Off, Ion/off Module Off, Ion/off Nodule Off, Ion/o	/o=1.2V	Vin=5V, 100% Load		85.0		%
Switching Frequency DN/OFF Control, (Negative logic) Logic Low Voltage Module On, Von/off Logic High Voltage Module Off, Von/off Vin-0.8 Vin,max Logic Low Current Module On, Ion/off Module Off, Ion/off Modu		Vin=5V, 100% Load		76.0		%
DN/OFF Control, (Negative logic) Logic Low Voltage Module On, Von/off Vin-0.8 Vin-1.6				600		1.1.1
Logic Low Voltage Module On, Von/off -0.2 Vin-1.6 Logic High Voltage Module Off, Von/off Vin-0.8 Vin,max Logic Low Current Module On, Ion/off 200 Logic High Current Module Off, Ion/off 0.2 1 DN/OFF Control, (Positive Logic) Control, (Positive Logic) 0.2 1 Logic High Voltage Module On, Von/off 1.6 Vin,max Logic Low Voltage Module Off, Von/off -0.3 0.3 Logic Low Current Module On, Ion/off 0.2 1 Logic High Current Module Off, Ion/off 0.1 2 Tracking Slew Rate Capability 0.1 2 Tracking Delay Time Delay from Vin.min to application of tracking voltage 10 Tracking Accuracy Power-up 2V/mS 100				600		kHz
Logic High Voltage		Module On, Von/off	-0.2		Vin-1.6	V
Logic High Current Module Off, Ion/off 0.2 1 DN/OFF Control, (Positive Logic) Logic High Voltage Module On, Von/off 1.6 Vin,max Logic Low Voltage Module Off, Von/off -0.3 0.3 0.3 Logic Low Current Module On, Ion/off 0.2 1 Logic High Current Module Off, Ion/off 0.2 1 Dracking Slew Rate Capability 0.1 2 1 Tracking Delay Time Delay from Vin.min to application of tracking voltage 10 100 Tracking Accuracy Power-up 2V/mS 100 Power-down 1V/mS 100		Module Off, Von/off				V
DN/OFF Control, (Positive Logic) Logic High Voltage Module On, Von/off 1.6 Vin,max						μΑ
Logic High Voltage Module On, Von/off 1.6 Vin,max Logic Low Voltage Module Off, Von/off -0.3 0.3 Logic Low Current Module On, Ion/off 0.2 1 Logic High Current Module Off, Ion/off 10 Dracking Slew Rate Capability 0.1 2 1 Tracking Delay Time Delay from Vin.min to application of tracking voltage 10 100 Tracking Accuracy Power-up 2V/mS 100 Power-down 1V/mS 100		Module Off, Ion/off		0.2	1	mA
Logic Low Voltage Module Off, Von/off -0.3 0.3 Logic Low Current Module On, Ion/off 0.2 1 Logic High Current Module Off, Ion/off 10 Incacking Slew Rate Capability 0.1 2 1 Tracking Delay Time Delay from Vin.min to application of tracking voltage 10 100 Tracking Accuracy Power-up 2V/mS 100 Power-down 1V/mS 100		Modulo On Von/off	1.6		Vin may	1/
Logic Low Current Module On, Ion/off 0.2 1 Logic High Current Module Off, Ion/off 10 Utracking Slew Rate Capability 0.1 2 V Tracking Delay Time Delay from Vin.min to application of tracking voltage 10 T Tracking Accuracy Power-up 2V/mS 100 Power-down 1V/mS 100						V
Logic High Current Module Off, Ion/off 10 OTracking Slew Rate Capability 0.1 2 V Tracking Delay Time Delay from Vin.min to application of tracking voltage 10 100 Tracking Accuracy Power-up 2V/mS 100 Power-down 1V/mS 100			-0.5	0.2		mA
OTracking Siew Rate Capability Tracking Delay From Vin.min to application of tracking voltage Tracking Accuracy Power-up 2V/mS Power-down 1V/mS 100						μA
Tracking Accuracy Power-up 2V/mS 100 Power-down 1V/mS 100	Tracking Slew Rate Capability					V/mse
Power-down 1V/mS 100			10		455	ms
	racking Accuracy	·				mV
	SENERAL SPECIFICATIONS	Power-gown TV/mS			100	mV
	ENERAL SPECIFICATIONS					M hou

(T_A = 25°C, airflow rate = 300 LFM, V_{in} =2.4Vdc to 5.5Vdc, nominal Vout unless otherwise noted.)



ELECTRICAL CHARACTERISTICS CURVES

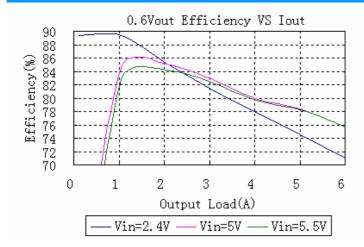


Figure 1: Converter efficiency vs. output current (0.6V out)

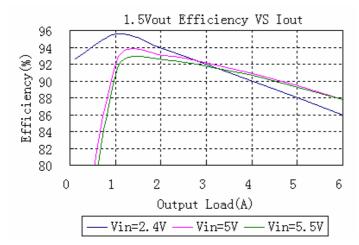


Figure 3: Converter efficiency vs. output current (1.5V out)

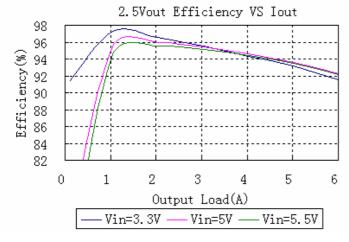


Figure 5: Converter efficiency vs. output current (2.5V out)

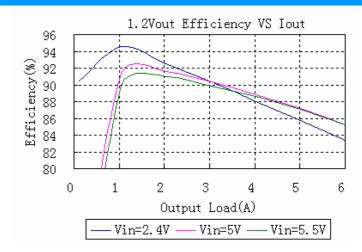


Figure 2: Converter efficiency vs. output current (1.2V out)

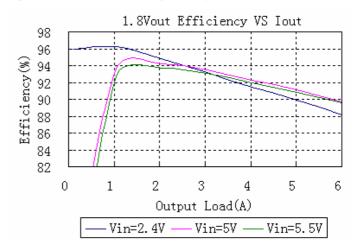


Figure 4: Converter efficiency vs. output current (1.8V out)

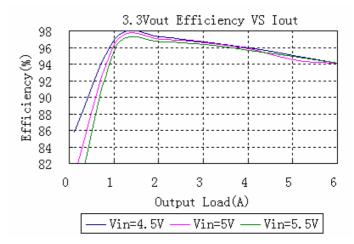
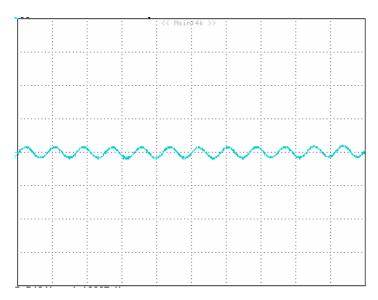


Figure 6: Converter efficiency vs. output current (3.3V out)

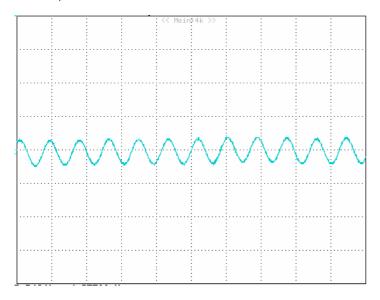


ELECTRICAL CHARACTERISTICS CURVES (CON.)



igure 7: Output ripple & noise at 5Vin, 0.6V/6A out. (2us/div and 5mV/div)

Figure 8: Output ripple & noise at 5Vin, 1.2V/6A out. (2us/div and 5mV/div)



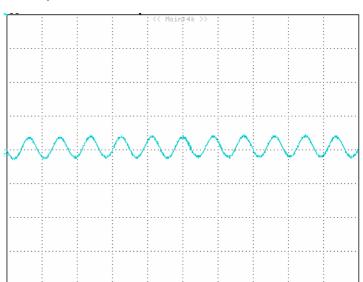


Figure 9: Output ripple & noise at 5Vin, 1.8V/6A out. (2us/div and 5mV/div)

Figure 10: Output ripple & noise at 5Vin, 3.3V/6A out. (2us/div and 5mV/div)



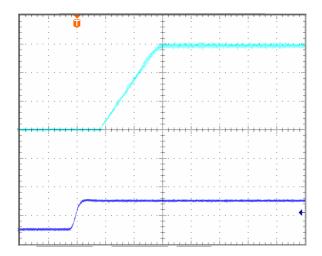


Figure 11: Turn on delay time at 5Vin, 0.6V/6A out(2mS/div),Top trace:Vout 0.2V/div; bottom trace:Vin,5V/div

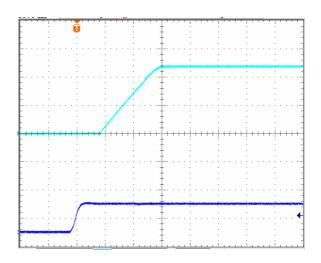


Figure 12: Turn on delay time at 5Vin, 1.2V/6A out(2mS/div),Top trace:Vout 0.5V/div; bottom trace:Vin,5V/div

ELECTRICAL CHARACTERISTICS CURVES (CON.)

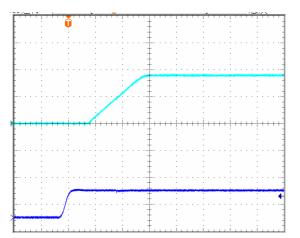


Figure 13: Turn on delay time at 5Vin, 1.8V/6A out(2mS/div), Top trace: Vout 1V/div; bottom trace: Vin, 5V/div

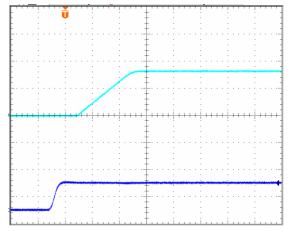


Figure 14: Turn on delay time at 5Vin, 3.3V/6A out(2mS/div), Top trace: Vout 2V/div; bottom trace: Vin, 5V/div

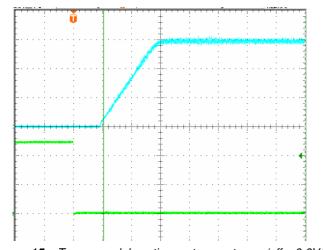


Figure 15: Turn on delay time at remote on/off, 0.6V/6A out(2mS/div), Top trace: Vout 0.2V/div; bottom trace: on/off, 2V/div

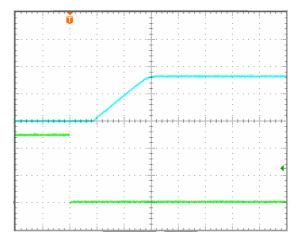


Figure 16: Turn on delay time at remote on/off, 3.3V/6A out(2mS/div), Top trace: Vout 2V/div; bottom trace: on/off, 2V/div



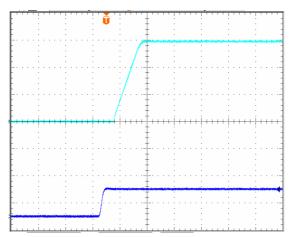


Figure 17: Turn on delay time at remote turn on with external capacitors ($Co=3000 \mu F$) 5Vin, 3.3V/6A out

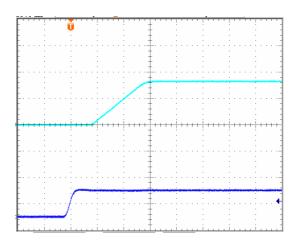


Figure 18: Turn on delay time at remote turn on with external capacitors ($Co=3000 \mu F$) 3.3Vin, 2.5V/6A out



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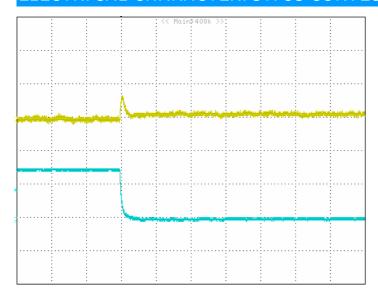


Figure 19: Typical transient response to step load change at 2.5A/μS from 50% to 0% of lo, max at 5Vin, 0.6Vout (200uS/div) (Cout = 47uF ceramic).top trace:Vout,0.1V/div;bottom trace:lout:2A/div.

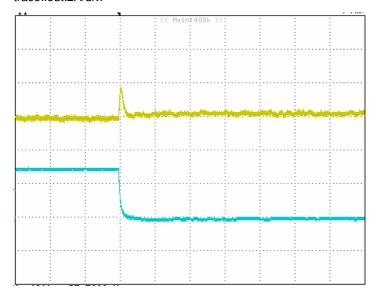


Figure 21: Typical transient response to step load change at 2.5A/μS from 50% to 0% of lo, max at 5Vin, 1.2Vout (200uS/div) (Cout = 47uF ceramic).top trace:Vout,0.1V/div;bottom trace:lout:2A/div.

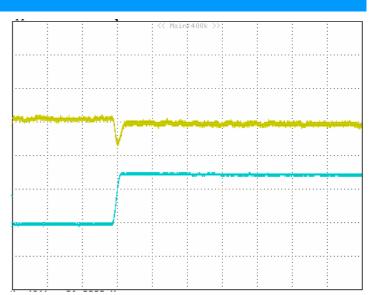


Figure 20: Typical transient response to step load change at 2.5A/μS from 0% to 50% of lo, max at 5Vin, 0.6Vout (200uS/div) (Cout = 47uF ceramic).top trace:Vout,0.1V/div;bottom trace:lout:2A/div.

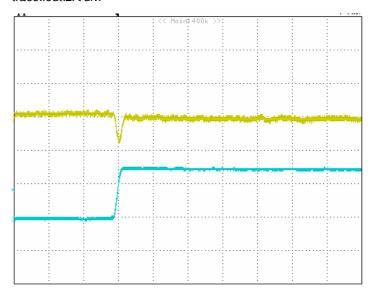


Figure 22: Typical transient response to step load change at 2.5A/μS from 0% to 50% of lo, max at 5Vin, 1.2Vout (200uS/div) (Cout = 47uF ceramic).top trace:Vout,0.1V/div;bottom trace:lout:2A/div.





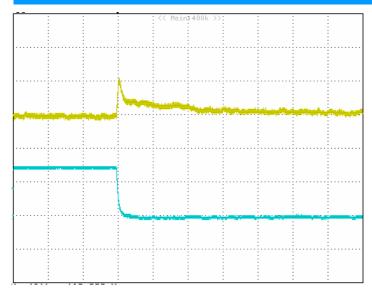


Figure 23: Typical transient response to step load change at 2.5A/μS from 50% to 0% of lo, max at 5Vin, 1.8Vout (200uS/div) (Cout = 47uF ceramic).top trace:Vout,0.1V/div;bottom trace:lout:2A/div.

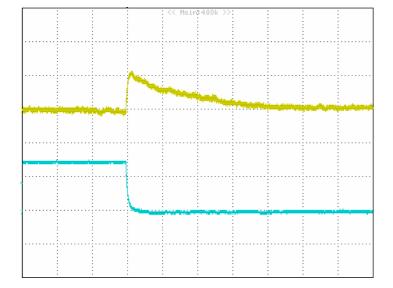


Figure 25: Typical transient response to step load change at 2.5A/μS from 50% to 0% of lo, max at 5Vin, 3.3Vout (200uS/div) (Cout = 47uF ceramic).top trace:Vout,0.1V/div;bottom trace:lout:2A/div.

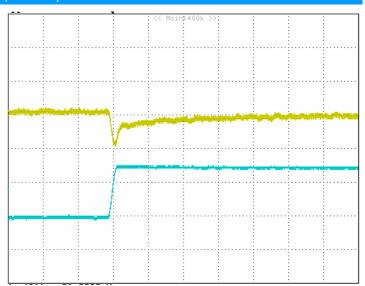


Figure 24: Typical transient response to step load change at 2.5A/μS from 0% to 50% of lo, max at 5Vin, 1.8Vout (200uS/div) (Cout = 47uF ceramic).top trace:Vout,0.1V/div;bottom trace:lout:2A/div.

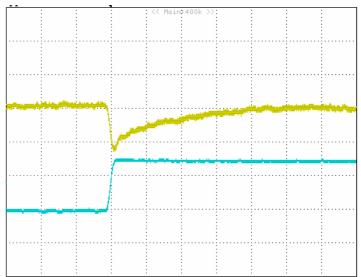


Figure 26: Typical transient response to step load change at 2.5A/μS from 0% to 50% of lo, max at 5Vin, 3.3Vout (200uS/div) (Cout = 47uF ceramic).top trace:Vout, 0.1V/div;bottom trace:lout:2A/div.



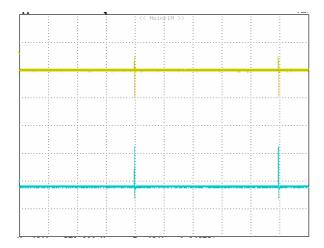


Figure 27: Output short circuit current 5Vin, 3.3Vout (10mS/div) Top trace:Vout,0.5V/div;Bottom trace:lout,5A/div

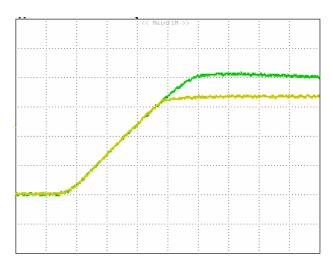
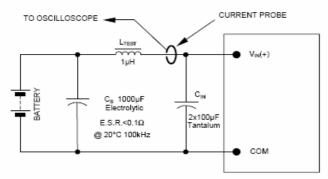


Figure 28:Tracking at 5Vin, 3.3V/6A out(1mS/div), tracking voltage=5V,top trace:Vseq,1V/div;bottom trace:Vout,1V/div

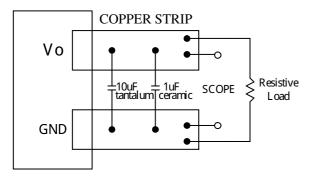


TEST CONFIGURATIONS



NOTE: Measure input reflected ripple current with a simulated source inductance (L_{TBST}) of 1µH. Capacitor C_S offsets possible battery impedance. Measure current as shown above.

Figure 29: Input reflected-ripple test setup



Note: Use a $10\mu F$ tantalum and $1\mu F$ capacitor. Scope measurement should be made using a BNC connector.

Figure 30: Peak-peak output noise and startup transient measurement test setup.

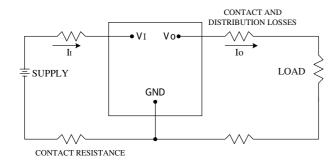


Figure 31: Output voltage and efficiency measurement test setup

Note: All measurements are taken at the module terminals. When the module is not soldered (via socket), place Kelvin connections at module terminals to avoid measurement errors due to contact resistance.

$$\eta = (\frac{Vo \times Io}{Vi \times Ii}) \times 100 \quad \%$$

DESIGN CONSIDERATIONS

Input Source Impedance

To maintain low noise and ripple at the input voltage, it is critical to use low ESR capacitors at the input to the module. A highly inductive source can affect the stability of the module. An input capacitance must be placed close to the modules input pins to filter ripple current and ensure module stability in the presence of inductive traces that supply the input voltage to the module.

The input capacitance should be able to handle an AC ripple current of at least:

$$Irms = Iout \sqrt{\frac{Vout}{Vin} \left(1 - \frac{Vout}{Vin}\right)} \quad Arms$$



DESIGN CONSIDERATIONS (CON.)

Safety Considerations

For safety-agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a maximum 10A fuse in the ungrounded lead.

Input Under voltage Lockout

At input voltages below the input under voltage lockout limit, the module operation is disabled. The module will begin to operate at an input voltage above the under voltage lockout turn-on threshold.

Over-Current Protection

To provide protection in an output over load fault condition, the unit is equipped with internal over-current protection. When the over-current protection is triggered, the unit enters hiccup mode. The units operate normally once the fault condition is removed.

FEATURES DESCRIPTIONS

Remote On/Off

The DCS series power modules have an On/Off pin for remote On/Off operation. Both positive and negative On/Off logic options are available in the DCS series power modules.

For negative logic module, connect an open collector (NPN) transistor or open drain (N channel) MOSFET between the On/Off pin and the GND pin (see figure 32). Negative logic On/Off signal turns the module ON during the logic high and turns the module OFF during the logic low. When the negative On/Off function is not used, tie the pin to GND (module will be On).

For positive logic module, the On/Off pin is pulled high with an external pull-up $5k\Omega$ resistor (see figure 33). Positive logic On/Off signal turns the module OFF during logic high and turns the module ON during logic low. If the Positive On/Off function is not used, tie the pin to Vin. (module will be On)

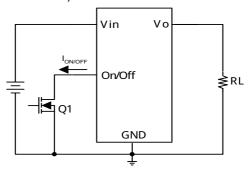


Figure 32: Negaitive remote On/Off implementation

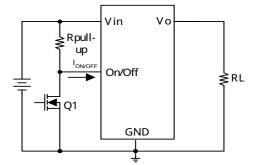


Figure 33: Positive remote On/Off implementation

Over-Current Protection

To provide protection in an output over load fault condition, the unit is equipped with internal over-current protection. When the over-current protection is triggered, the unit enters hiccup mode. The units operate normally once the fault condition is removed.



FEATURES DESCRIPTIONS (CON.)

Remote Sense

The DCS provide Vo remote sensing to achieve proper regulation at the load points and reduce effects of distribution losses on output line. In the event of an open remote sense line, the module shall maintain local sense regulation through an internal resistor. The module shall correct for a total of 0.5V of loss. The remote sense line impedance shall be < 10Ω .

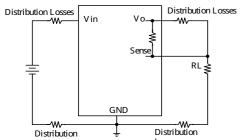


Figure 34: Effective circuit configuration for remote sense operation

Output Voltage Programming

The output voltage of the DCS can be programmed to any voltage between 0.6Vdc and 3.3Vdc by connecting one resistor (shown as Rtrim in Figure 35) between the TRIM and GND pins of the module. Without this external resistor, the output voltage of the module is 0.6 Vdc. To calculate the value of the resistor Rtrim for a particular output voltage Vo, please use the following equation:

$$Rtrim = \left[\frac{1.2}{Vo - 0.6}\right] k\Omega$$

For example, to program the output voltage of the DCS module to 1.8Vdc, Rtrim is calculated as follows:

$$Rtrim = \left[\frac{1.2}{1.8 - 0.6}\right] k\Omega = 1K\Omega$$

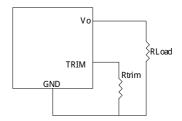


Figure 35: Circuit configuration for programming output voltage using an external resistor

Table 1 provides Rtrim values required for some common output voltages, By using a 0.5% tolerance trim resistor, set point tolerance of $\pm 1.5\%$ can be achieved as specified in the electrical specification.

Table 1

0.6V	Open			
1V	3K			
1.2V	2K			
1.5V	1.333K			
1.8V	1K			
2.5V	0.632K			
3.3V	0.444K			

Certain restrictions apply on the output voltage set point depending on the input voltage. These are shown in the Output Voltage vs. Input Voltage Set Point Area plot in Figure 36. The Upper Limit curve shows that for output voltages of 3.3V and lower, the input voltage must be lower than the maximum of 5.5V. The Lower Limit curve shows that for output voltages of 1.8V and higher, the input voltage needs to be larger than the minimum of 2.4V.

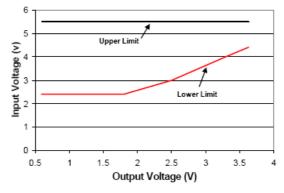


Figure 36: Output Voltage vs. Input Voltage Set Point Area plot showing limits where the output voltage can be set for different input voltages.



FEATURE DESCRIPTIONS (CON.)

The amount of power delivered by the module is the voltage at the output terminals multiplied by the output current. When using the trim feature, the output voltage of the module can be increased, which at the same output current would increase the power output of the module. Care should be taken to ensure that the maximum output power of the module must not exceed the maximum rated power (Vo.set x Io.max $\le P$ max).

Voltage Margining

Output voltage margining can be implemented in the DCS modules by connecting a resistor, R margin-up, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, Rmargin-down, from the Trim pin to the output pin for margining-down. Figure 3 shows the circuit configuration for output voltage margining. If unused, leave the trim pin unconnected. A calculation tool is available from the evaluation procedure which computes the values of Rmargin-up and Rmargin-down for a specific output voltage and margin percentage.

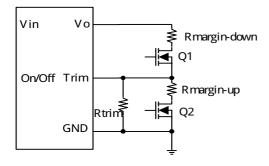


Figure 37: Circuit configuration for output voltage margining

Output Voltage Sequencing

The DCS 12V 6A modules include a sequencing feature, EZ-SEQUENCE that enables users to implement various types of output voltage sequencing in their applications. This is accomplished via an additional sequencing pin. When not using the sequencing feature, either tie the SEQ pin to VIN or leave it unconnected.

When an analog voltage is applied to the SEQ pin, the output voltage tracks this voltage until the output reaches the set-point voltage. The final value of the SEQ voltage must be set higher than the set-point voltage of the module. The output voltage follows the voltage on the SEQ pin on a one-to-one basis. By connecting multiple modules together, multiple modules can track their output voltages to the voltage applied on the SEQ pin. For proper voltage sequencing, first, input voltage is applied to the module. The On/Off pin of the module is left unconnected (or tied to GND for negative logic modules or tied to VIN for positive logic modules) so that the module is ON by default. After applying input voltage to the module, a minimum 10msec delay is required before applying voltage on the SEQ pin. This delay gives the module enough time to complete its internal power-up soft-start cycle. During the delay time, the SEQ pin should be held close to ground (nominally 50mV ± 20 mV). This is required to keep the internal op-amp out of saturation thus preventing output overshoot during the start of the sequencing ramp. By selecting resistor R1 (see Figure. 38) according to the following equation

$$R1 = \left[\frac{24950}{Vin - 0.05}\right]\Omega$$

The voltage at the sequencing pin will be 50mV when the sequencing signal is at zero.



FEATURE DESCRIPTIONS (CON.)

After the 10msec delay, an analog voltage is applied to the SEQ pin and the output voltage of the module will track this voltage on a one-to-one volt bases until the output reaches the set-point voltage. To initiate simultaneous shutdown of the modules, the SEQ pin voltage is lowered in a controlled manner. The output voltage of the modules tracks the voltages below their set-point voltages on a one-to-one basis. A valid input voltage must be maintained until the tracking and output voltages reach ground potential.

When using the EZ-SEQUENCETM feature to control start-up of the module, pre-bias immunity during startup is disabled. The pre-bias immunity feature of the module relies on the module being in the diode-mode during start-up. When using the EZ-SEQUENCETM feature, modules goes through an internal set-up time of 10msec, and will be in synchronous rectification mode when the voltage at the SEQ pin is applied. This will result in the module sinking current if a pre-bias voltage is present at the output of the module.

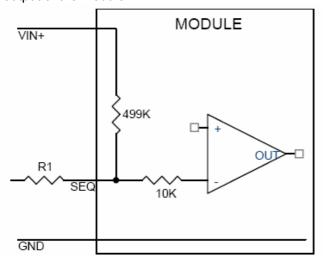


Figure 38: Circuit showing connection of the sequencing signal to the SEQ pin.

Monotonic Start-up and Shutdown

The DCS 6A modules have monotonic start-up and shutdown behavior for any combination of rated input voltage, output current and operating temperature range.



THERMAL CONSIDERATIONS

Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

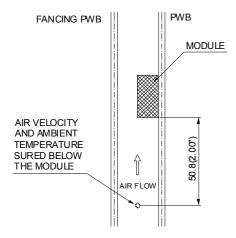
Thermal Testing Setup

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a test PWB and is vertically positioned within the wind tunnel.

Thermal Derating

Heat can be removed by increasing airflow over the module. To enhance system reliability, the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 39: Wind tunnel test setup

THERMAL CURVES

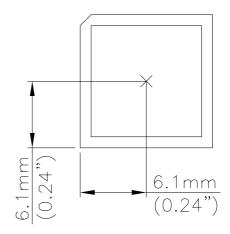


Figure 40: Temperature measurement location
The allowed maximum hot spot temperature is defined at 109° C

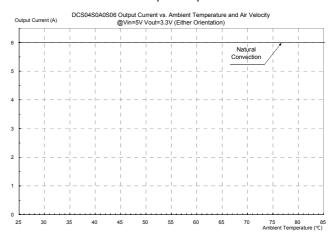


Figure 41: Output current vs. ambient temperature and air velocity@Vin=5V, Vout=3.3V(Either Orientation)

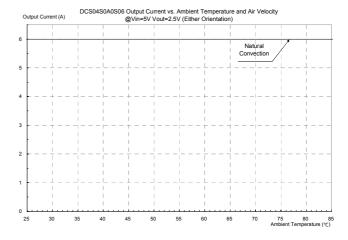


Figure 42: Output current vs. ambient temperature and air velocity@Vin=5V, Vout=2.5V(Either Orientation)



THERMAL CURVES

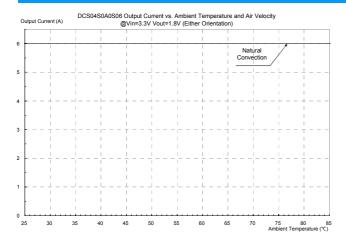


Figure 43: Output current vs. ambient temperature and air velocity@Vin=3.3V, Vout=1.8V(Either Orientation)

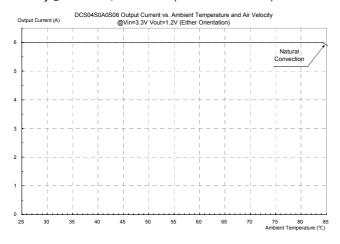


Figure 44: Output current vs. ambient temperature and air velocity@Vin=3.3V, Vout=1.2V(Either Orientation)

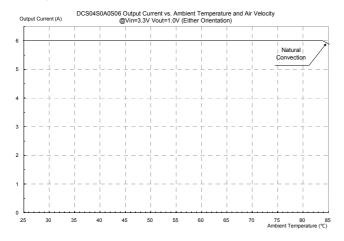


Figure 45: Output current vs. ambient temperature and air velocity@Vin=3.3V, Vout=1.0V(Either Orientation)

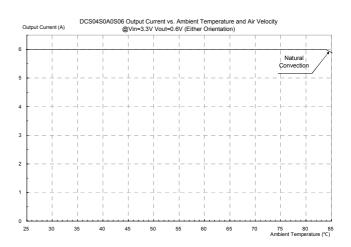
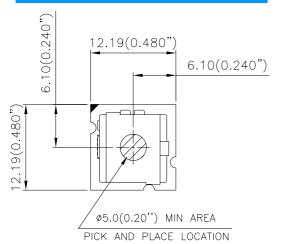


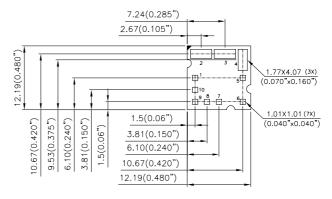
Figure 46: Output current vs. ambient temperature and air velocity@Vin=3.3V, Vout=0.6V(Either Orientation)



PICK AND PLACE LOCATION



RECOMMENDED PAD LAYOUT



PIN#	FUNCTION			
1	ON/OFF			
2	VIN			
3	GND			
4	VOUT			
5	SENSE			
6	TRIM			
7	GND			
8	NC			
9	SEQ			
10	NC			

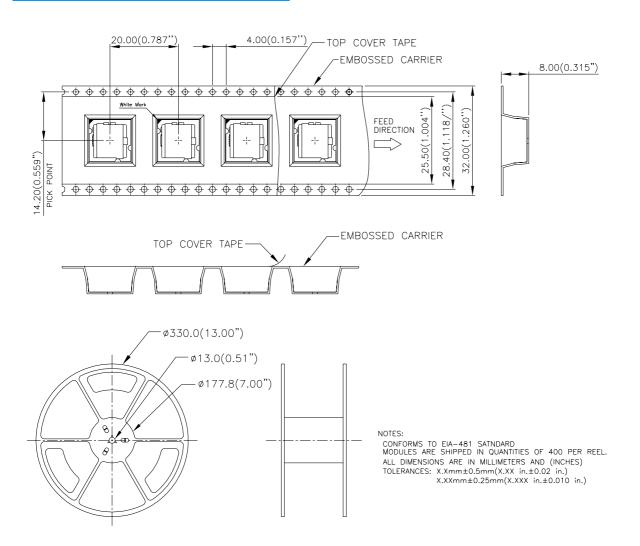
RECOMENDED P.W.B. PAD LAYOUT

NOTES:

ALL DIMENSIONS ARE IN MILLIMETERS AND (INCHES) TOLERANCES: $X.Xmm\pm0.5mm(X.XX in.\pm0.02 in.)$ $X.XXmm\pm0.25mm(X.XXX in.\pm0.010 in.)$

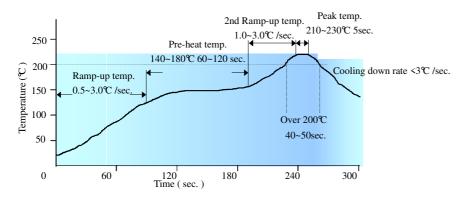
NOTES:

SURFACE-MOUNT TAPE & REEL



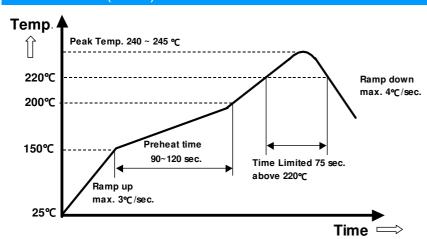


LEAD (Sn/Pb) PROCESS RECOMMEND TEMP. PROFILE



Note: The temperature refers to the pin of DCS, measured on the pin Vout joint.

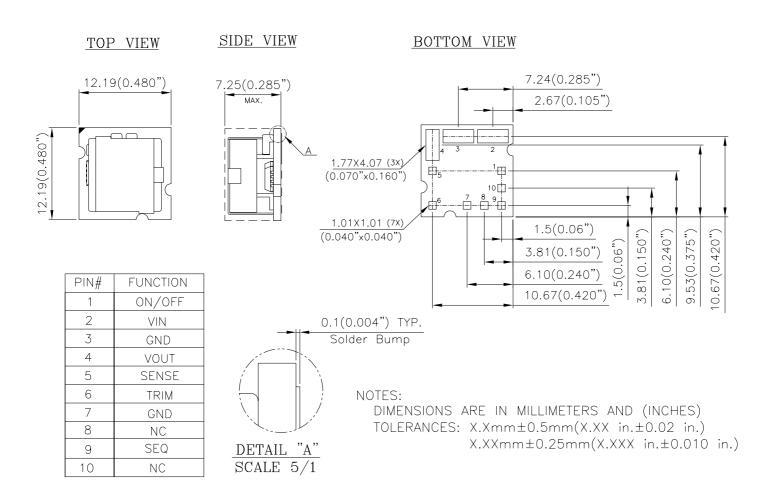
LEAD FREE (SAC) PROCESS RECOMMEND TEMP. PROFILE



Note: The temperature refers to the pin of DCS, measured on the pin Vout joint.



MECHANICAL DRAWING





PART NUMBERING SYSTEM								
DCS	04	S	0A0	S	06	N	F	A
Product Series	Input Voltage	Numbers of Outputs	Output Voltage	Package Type	Output Current	On/Off logic		Option Code
DCS - 6A DCM - 12A DCL - 20A	04 - 2.4~5.5V 12 – 4.5~14V	S - Single	0A0 - Programmable	S - SMD	06 - 6A 12 - 12A 20 - 20A	N- negative P- positive	F- RoHS 6/6 (Lead Free)	A - Standard Function

MODEL LIST					
Model Name	Packaging	Input Voltage	Output Voltage	Output Current	Efficiency 5.0Vin, 3.3Vdc @ 6A
DCS04S0A0S06NFA	SMD	2.4 ~ 5.5Vdc	0.6V~ 3.63Vdc	6A	94.0%

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WARRANTY

Delta offers a two (2) year limited warranty. Complete warranty information is listed on our web site or is available upon request from Delta.

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